



## Product Change Notification: DSNO-11CVSI654

**Date:**

03-Dec-2025

**Product Category:**

Automotive LED Drivers, General Purpose LED Drivers

**Notification Subject:**

CCB 7630 Initial Notice: Qualification of ATP7 as an additional assembly site for AT9919K7-GVAO, HV9918K7-G, HV9919BK7-G, AT9919K7-G and HV9967BK7-G catalog part numbers (CPN) available in 8L WDFN (3x3x0.8mm) package.

**Affected CPNs:**

[\*\*DSNO-11CVSI654\\_Affected\\_CPN\\_12032025.pdf\*\*](#)

[\*\*DSNO-11CVSI654\\_Affected\\_CPN\\_12032025.csv\*\*](#)

**PCN Status:** Initial Notification

**PCN Type:** Manufacturing Change

**Microchip Parts Affected:** Please open one of the files found in the Affected CPNs section.  
Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:** Qualification of ATP7 as an additional assembly site for AT9919K7-GVAO, HV9918K7-G, HV9919BK7-G, AT9919K7-G and HV9967BK7-G catalog part numbers (CPN) available in 8L WDFN (3x3x0.8mm) package.

**Pre and Post Summary Changes:**

	<b>Pre Change</b>	<b>Post Change</b>		<b>Change (Yes/No)</b>
<b>Assembly Site</b>	Carsem (Suzhou) (CARC)	Carsem (Suzhou) (CARC)	Amkor Technology Philippines (P3/P4), INC. (ATP7)	Yes

<b>Wire Material</b>	Au	Au	Au	No
<b>Die Attach Material</b>	QMI519	QMI519	AP4300	Yes
<b>Molding Compound Material</b>	G770HD	G770HD	G631BQF	Yes
<b>Lead-Frame Material</b>	C194	C194	C194	No
<b>Lead-Frame Paddle Size</b>	104x75 mils	104x75 mils	106x75 mils	Yes
<b>DAP Surface Prep</b>	Ag Spot	Ag Spot	Ring Ag	Yes
	See Pre and Post Change Summary attachment for comparison.			

## Impacts to Datasheet: None

### Change Impact: None

**Reason for Change:** To improve on-time delivery performance by qualifying ATP7 as an additional assembly site.

## Change Implementation Status: In Progress

**Estimated Qualification Completion Date:** December 2025

**Note:** Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

## Timetable Summary:

**Method to Identify Change:** Traceability Code

**Qualification Plan:** Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Plan.

**Revision History:** June 17, 2025: Issued initial notification.

December 03, 2025: Re-issued initial notification. Update the post-change wire material (at ATP7) from "CuPdAu" to "Au". Added a 'Change (Yes/No)' column to the Pre and Post Change Summary table. Updated the Qualification Report format from Q006 qualification to Q100 qualification.

**Note:** The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

## **Attachments:**

[\*\*PCN\\_DSNO-11CVSI654\\_Pre and Post Change Summary.pdf\*\*](#)

[\*\*PCN\\_DSNO-11CVSI654\\_Qualification\\_Plan.pdf\*\*](#)

Please contact your local [\*\*Microchip sales office\*\*](#) with questions or concerns regarding this notification.

## **Terms and Conditions:**

If you wish to [receive Microchip PCNs via email](#) please register for our PCN email service at our [\*\*PCN home page\*\*](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [\*\*PCN FAQ\*\*](#) section.

If you wish to [change your PCN profile, including opt out](#), please go to the [\*\*PCN home page\*\*](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.